



**ZXTN4004Z**

**150V NPN LED DRIVING TRANSISTOR IN SOT89**

**Features**

- $BV_{CEO} > 150V$
- $h_{FE} > 100$  for  $I_C = 150mA$ ,  $V_{CE} = 0.25V$
- Maximum continuous current  $I_C = 1A$
- **Lead Free, RoHS Compliant (Note 1)**
- **Halogen and Antimony Free "Green" Device (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Applications**

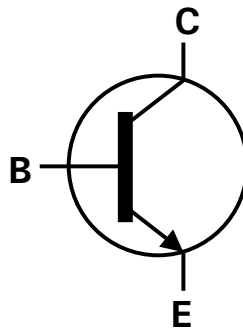
- LED TV backlight

**Mechanical Data**

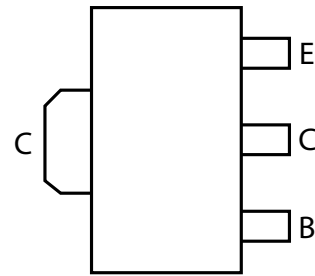
- Case: SOT89
- Case material: molded Plastic. "Green" molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.052 grams (Approximate)



Top View



Device Symbol



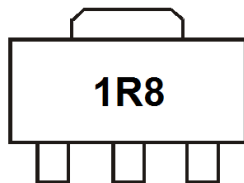
Top View Pin-Out

**Ordering Information**

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTN4004ZTA	1R8	7	12	1000 units

- Notes:
1. No purposefully added lead.
  2. "Green" devices, Halogen and Antimony Free, Diodes Inc's "Green" Policy can be found on our website at <http://www.diodes.com>

**Marking Information**



1R8 = Product type Marking Code

**Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

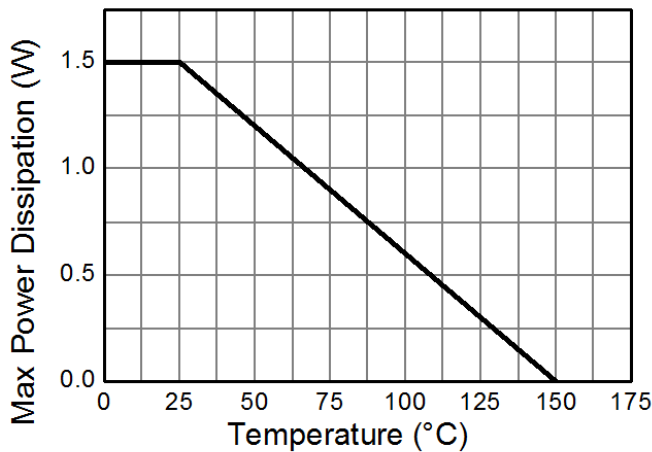
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	150	V
Collector-Emitter Voltage	V <sub>CEO</sub>	150	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Continuous Collector Current	I <sub>C</sub>	1	A
Peak Pulse Current (Note 4)	I <sub>CM</sub>	3	A
Base Current	I <sub>B</sub>	500	mA

**Thermal Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

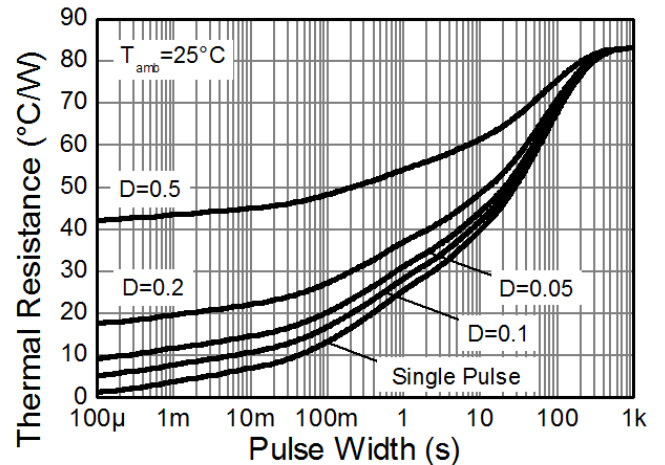
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	P <sub>D</sub>	1.5	W
Thermal Resistance, Junction to Ambient (Note 3)	R <sub>θJA</sub>	83	°C/W
Thermal Resistance, Junction to Leads (Note 5)	R <sub>θJL</sub>	16.2	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

- Notes:
- For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions
  - Measured under pulsed conditions. Pulse width = 300µs. Duty cycle ≤ 2%.
  - Thermal resistance from junction to solder-point (on the exposed collector pad).

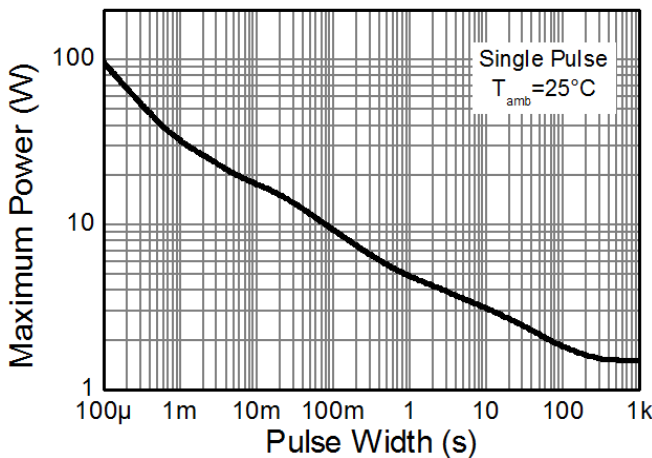
**Thermal Characteristics and Derating Information**



**Derating Curve**



**Transient Thermal Impedance**



**Pulse Power Dissipation**

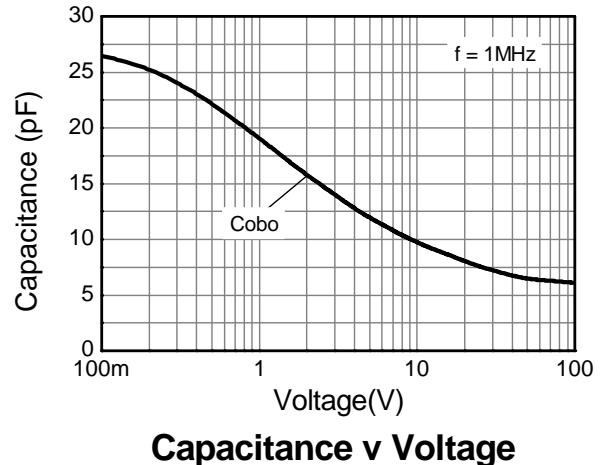
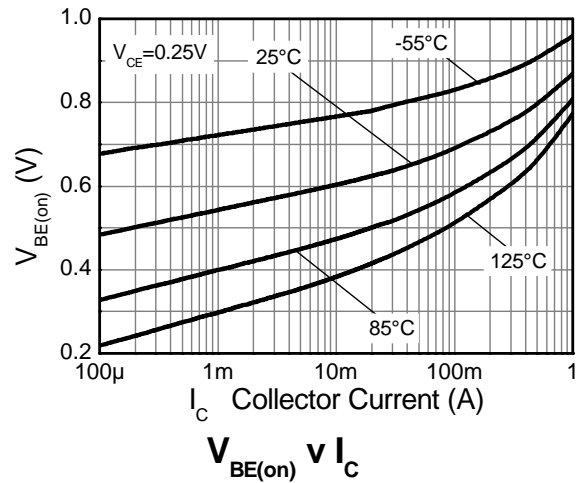
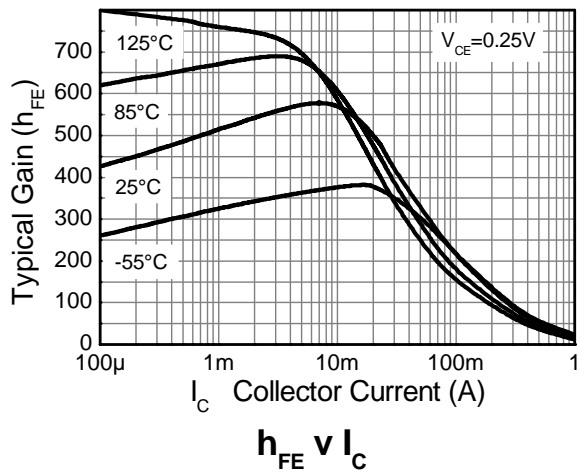
**ZXTN4004Z**

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Emitter Breakdown Voltage (Note 6)	BV <sub>CEO</sub>	150	175	-	V	I <sub>C</sub> = 10mA
Collector Cut-off Current	I <sub>CBO</sub>	-	-	50	nA	V <sub>CB</sub> = 150V
Emitter Cut-off Current	I <sub>EBO</sub>	-	-	50	nA	V <sub>EB</sub> = 7V
Static Forward Current Transfer Ratio (Note 6)	h <sub>FE</sub>	60 100	- -	- -	-	I <sub>C</sub> = 85mA, V <sub>CE</sub> = 0.20V I <sub>C</sub> = 150mA, V <sub>CE</sub> = 0.25V
Base-Emitter Turn-On Voltage (Note 6)	V <sub>BE(on)</sub>	-	0.71	0.95	V	I <sub>C</sub> = 150mA, V <sub>CE</sub> = 0.25V
Delay Time	t <sub>(d)</sub>	-	512	-	ns	V <sub>CC</sub> = 120V, I <sub>C</sub> = 150mA, -I <sub>B2</sub> = 1.5mA, V <sub>CE(ON)</sub> = 0.25V
Rise Time	t <sub>(r)</sub>	-	426	-	ns	
Storage Time	t <sub>(s)</sub>	-	3413	-	ns	
Fall Time	t <sub>(f)</sub>	-	321	-	ns	V <sub>CC</sub> = 120V, I <sub>C</sub> = 150mA, -I <sub>B2</sub> = 1.5mA, V <sub>CE(ON)</sub> = 4V
Storage Time	t <sub>(s)</sub>	-	65	-	ns	
Fall Time	t <sub>(f)</sub>	-	294	-	ns	

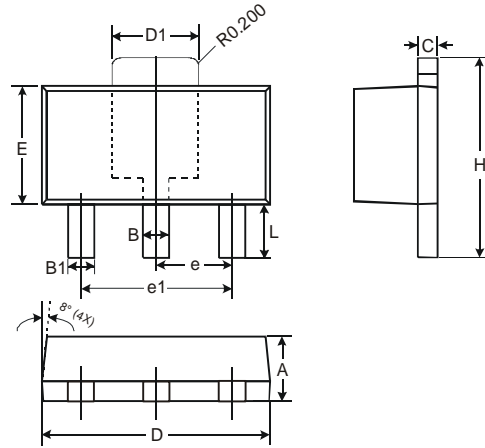
Notes: 6. Measured under pulsed conditions. Pulse width = 300µs. Duty cycle ≤ 2%

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified



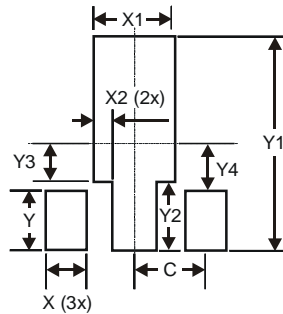
**ZXTN4004Z**

**Package Outline Dimensions**



SOT89		
Dim	Min	Max
A	1.40	1.60
B	0.44	0.62
B1	0.35	0.54
C	0.35	0.43
D	4.40	4.60
D1	1.52	1.83
E	2.29	2.60
e	1.50 Typ	
e1	3.00 Typ	
H	3.94	4.25
L	0.89	1.20
All Dimensions in mm		

**Suggested Pad Layout**



Dimensions	Value (in mm)
X	0.900
X1	1.733
X2	0.416
Y	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
C	1.500

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